

# PATENT ASSIGNMENT

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<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
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<b>Name</b>	<b>Execution Date</b>
Shu-Yuen Ron HUI	02/14/2006
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	City University of Hong Kong
<b>Street Address:</b>	Tat Chee Avenue
<b>City:</b>	Kowloon, Hong Kong
<b>State/Country:</b>	CHINA
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	11610860
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# ASSIGNMENT

WHEREAS, I, **Shu-Yuen Ron HUI**, a citizen of Australia, residing at 2B, Block 29, Greenwood Terrace, 26-28 Sui Wo Road, Shatin, New Territories, Hong Kong, have invented certain new and useful improvements in **PLANAR INDUCTIVE BATTERY CHARGER** for which I have executed an application for Letters Patent of the United States, Application Serial Number 11/009,478, filed on December 10, 2004; and

WHEREAS, **City University of Hong Kong** having offices at Tat Chee Avenue, Kowloon, Hong Kong, is desirous of obtaining the entire right, title and interest in, to and under the said improvements and the said application;

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, I the said **Shu-Yuen Ron HUI** have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said **City University of Hong Kong**, its successors, legal representatives and assigns, the entire right, title and interest in, to and under the said improvements, and the said application and all divisions, renewals and continuations thereof, and all Letters Patent which may be granted thereon and all reissues and extensions thereof, and all applications for Letters Patent which may hereafter be filed for said improvements in any country or countries foreign to the United States, and all Letters Patent which may be granted for said improvements in any country or countries foreign to the United States and all extensions, renewals and reissues thereof; and I hereby authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications as aforesaid, to issue all Letters Patent for said improvements to the said **City University of Hong Kong**, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND I HEREBY covenant that I have full right to convey the entire interest herein assigned, and that I have not executed, and will not execute, any agreement in conflict herewith.

AND I HEREBY further covenant and agree that I will communicate to the said **City University of Hong Kong**, its successors, legal representatives and assigns, any facts known to me respecting said improvements, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing and reissue applications, make all rightful oaths and generally do everything possible to aid the said **City University of Hong Kong**, its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said improvements in all countries.

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this 14 day of February, 2006.

Ron Hui  
Shu-Yuen Ron HUI

[Signature]  
Witness  
[Signature]  
Witness